

# INORGANIC CHEMISTRY

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# Interface engineering of lithium metal anodes via atomic and molecular layer deposition

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Rechargeable batteries are playing an ever-increasing important role in our society. Their performance (such as cell cyclability, safety, and lifespan) is critical for their applications. Among the various factors related to cell performance, interfaces, which ubiquitously exist between an electrode and an electrolyte, have some significant functions. They mostly evolve and degrade with cell cycling. Thus, an ideal interface should be physically and electrochemically stable and able to provide a compatible environment for electrolytes and electrodes in cells. To this end, interface engineering is needed and has become an important area. It has been achieved via different strategies. In the last decade, atomic layer deposition (ALD) has emerged as a new strategy. It enables accurate interface modification via coating electrodes with desirable inorganic films at the atomic level and has created a long coating list to date. Complementarily, molecular layer deposition (MLD) extends the list to organic and organic-inorganic hybrid coatings. More amazingly, their combinations could further make the list uncountable. Owing to numerous efforts using ALD and MLD for advancing lithium-ion batteries (LIBs), there has recently been an ever-growing interest in lithium metal batteries (LMBs). In this review, we focus on summarizing the studies addressing the most forbidding issues of lithium metal anodes in LMBs using ALD and MLD. The inherent merits of ALD and MLD have made them two irreplaceable tools for opening up new technical avenues to commercialize LMBs.

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#### Introduction

Fossil fuels (coal, gas, and oil) have been serving as our main energy supplies in the past century, accounting for over 80% of the total energy consumed annually. Such continuous huge consumption is leading to quick depletion while causing many environmental issues and changing our ecosystems. To tackle these challenges for achieving a long-term sustainable society, electrification is promising and can facilitate the wide implementation of renewable energies such as solar and wind power. To this end, portable electrical energy storage (EES) systems are critical, which store electricity harvested from renewable energy sources and supply it to energy-consumption sectors, e.g., portable electronics, electric vehicles (EVs), and smart grids. In this respect, lithium-ion batteries (LIBs) are to date the most successful EES devices playing a dominant role in portable electronics. Additionally, transportation electrification is significant, as transportation is consuming nearly one third of the total energy.1 Currently, LIBs are penetrating the EV market, while governments worldwide are setting various programs to spur EV sales. In this context, better batteries are urgently needed, as state-of-the-art LIBs are still insufficient in

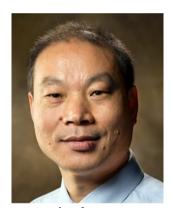
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multiple aspects, including energy density, cost, safety, and lifetime.2-4 A desirable battery technology for EVs needs to satisfy an energy density of  $\geq 300$  W h kg<sup>-1</sup>, low cost (<\$125 kW per h), long lifespan (>15 calendar years), and reliable safety free of fire and explosion.<sup>5-7</sup>

To radically boost the market share of EVs, lithium metal batteries (LMBs) have been proposed and undergoing intensive investigation, featuring the replacement of graphite anodes in LIBs with lithium metal (Li) anodes. This change promises a much higher energy density of LMBs, as the Li metal has the lowest negative electrochemical potential (-3.04 V versus the standard hydrogen electrode) and the highest theoretical capacity of 3860 mA h g<sup>-1</sup> at room temperature, more than 10 times higher than that of the graphite anodes (372 mA h g<sup>-1</sup>) in LIBs.8-12 Consequently, the Li metal has been regarded as an ultimate anode material and can be used to couple with nearly any cathode to constitute an LMB cell. The cathodes can be any existing cathodes used in LIBs such as LiCoO<sub>2</sub> (LCO), LiMn<sub>2</sub>O<sub>4</sub> (LMO), LiFePO<sub>4</sub> (LFP), LiNi<sub>x</sub>Mn<sub>y</sub>Co<sub>z</sub>O<sub>2</sub> (NMCs, x + y + z = 1), and LiNi<sub>x</sub>Co<sub>y</sub>Al<sub>z</sub>O<sub>2</sub> (NCAs, x + y + z = 1). They also can be any emerging cathodes such as sulfur (S) and oxygen (O<sub>2</sub>). Thus, there are a variety of LMBs under development.

Although LMBs are very promising, their commercialization is a challenge. Their limitations are closely related to electrodes (Li metal anodes and cathodes), electrolytes, and interfaces between them. Traditionally, organic liquid electrolytes (oLEs) are widely used in LIBs, while solid-state electrolytes (SEs) are undergoing extensive investigation. SEs can be polymeric (i.e., pSEs), inorganic (iSEs), or composite (cSEs). No matter what electrolyte is applied in an LMB system, the interface between the electrode (either an Li metal anode or a cathode) and the electrolyte plays a prominent role, which has some significant impacts on the resulting cell's performance. Owing to the highly negative electrochemical potential of Li<sup>+</sup>/Li, any electrolyte can be readily reduced at the Li surface with the production of a layer of solid electrolyte interphase (SEI). However, electrolytes are prone to oxidation at cathodes at high potentials to form a layer of cathode electrolyte interphase (CEI). Both SEI and CEI are mosaic in composition and heterogenous in ionic conductivity. As a result, Li<sup>+</sup> ions may deposit preferentially and grow into dendritic structures on the Li anode side during an Li plating process. The resulting Li dendrites are in core-shell structures, i.e., having an Li metal core and an SEI shell. They may grow into the cathode side and thereby get the cell shorted. Thus, Li dendrites pose serious safety issues.

In summary, the Li metal suffers from two main issues: high reactivity to electrolytes with the production of SEI and



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Research Fellow (2012-2016) in Energy Systems Division at Argonne National Laboratory (Lemont, IL) and a Research Associate (2011-2012) in the Chemistry Department at Brookhaven National Laboratory (Upton, NY). He was the recipient of a Canada NSERC Postdoctoral Fellowship (2011-2013), the AVS Student Award in ALD (2011), and the 2nd Prize of OCE Competition (2008). He was also the nominee of the Canadian CGS/UMI Distinguished Dissertation Award (2009) and Moore Inventor Fellows (2017). His interests lie in smartly designing novel nanostructured materials for a wide range of applications such as energy, catalysis, semiconductors, surface engineering, and biomedicine. Currently, Dr Meng's research focuses on developing new chemical processes for growing new inorganic, organic, and hybrid nanomaterials in a precisely controllable mode using both atomic and molecular layer deposition (ALD and MLD), and on developing high-performance advanced battery systems, including lithium-ion batteries, lithium-sulfur batteries, sodium-ion batteries, solid-state batteries, and microbatteries.

dendritic growth during plating. Particularly, the Li dendritic growth and SEI formation are interconnected and self-accelerated. This makes the use of Li metal as a practical anode very difficult, hampering the commercialization of LMBs. To address these two issues of Li metal anodes for commercializing LMBs, there have been an increasing number of efforts reported in the literature. Among the various efforts, surface coating has been an important strategy to practice interface engineering of Li anodes. It is important that a coating should be applied on Li anodes at a temperature lower than the melting point of the Li metal of ~180 °C. It should be uniform, conformal, and tunable for achieving desirable properties. Traditional deposition techniques are unsatisfactory for this. Chemical vapor deposition (CVD), 13 for instance, requires high temperatures (e.g., 600 °C or higher), while physical vapor deposition (PVD), e.g., sputtering and vaporization, 14 suffers from its limited material choices and its line-ofsight deposition nature. Furthermore, they both are unable to control the coating thickness accurately. In this context, atomic and molecular layer deposition (ALD and MLD) have emerged as two unique vapor deposition tools, showing excellent capabilities to provide novel solutions, ascribed to their distinctive merits including low process temperature (≤150 °C), extremely uniform and conformal coating, and unlimited material choices. 15,16 Since their first application in LIBs at the very beginning of the 2000s, they have been well recognized as two important techniques for interface engineering of rechargeable batteries. 17-19 In this work, we focus on summarizing the recent progresses of ALD and MLD for interface engineering of Li metal anodes in LMBs and showcase the most encouraging studies. We expect that this effort would shed some light on the applications of ALD and MLD for interface engineering of Li metal anodes and stimulate many more efforts using them to develop new technical solutions for LMBs.

## Briefing on ALD and MLD

ALD and MLD are two sister vapor-phase thin film techniques, sharing analogous growth mechanisms that make them possible to accurately control material growth. ALD is exclusively used for growing inorganic materials at the atomic level, while MLD is used specifically for growing organic or organic-inorganic hybrid materials at the molecular level.20 They both commonly rely on alternative self-limiting surface reactions to achieve material growth in a layer-by-layer mode. As illustrated in Fig. 1a, the growth mechanism of ALD is exemplified by the model process of Al2O3 using trimethylaluminum (TMA, Al (CH<sub>3</sub>)<sub>3</sub>) and H<sub>2</sub>O as precursors. It proceeds with two half-reactions alternatively on the substrate surface, as described in equations of (1A) and (1B) as follows:21

$$|-OH + Al(CH_3)_3(g) \rightarrow |-O-Al(CH_3)_2 + CH_4(g)$$
 (1A)

$$\left| \text{-O-Al(CH}_3)_2 + 2\text{H}_2\text{O(g)} \rightarrow \left| \text{-OAl(OH)}_2 + 2\text{CH}_4(\text{g}) \right. \right. \tag{1B}$$

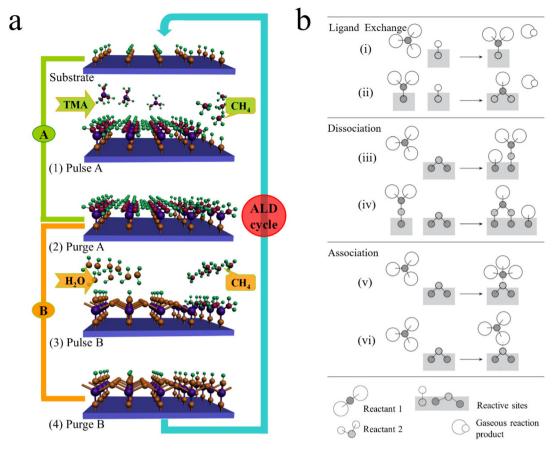


Fig. 1 Schematic illustrations of (a) the ALD process, which is exemplified by that ALD Al<sub>2</sub>O<sub>3</sub> using TMA and water as precursors<sup>17</sup> and (b) the chemisorption mechanisms possible in ALD.<sup>22</sup> Reprinted with permission from ref. 17. Copyright (2012) John Wiley & Sons. Reprinted with permission from ref. 22. Copyright (2003) John Wiley & Sons.

where "|" indicates substrate surfaces while "(g)" signifies gas phases. The surface chemistry of the ALD Al<sub>2</sub>O<sub>3</sub> is mainly based on ligand exchanges between -OH and -CH3 to arrange atoms accurately in a layer-by-layer fashion. In addition to ligand exchange, there are two other chemisorption mechanisms for the surface chemistry of ALD processes: dissociation and association (as illustrated in Fig. 1b). 22,23 The self-limiting or self-terminating nature of the surface reactions is typically caused by either of the two factors: steric hindrance of ligands and limited number of bonding sites. 22 This has further determined the growth accuracy of ALD and its other unique characteristics. The four steps (from 1 to 4 in Fig. 1a, i.e., pulse A/ purge A/pulse B/purge B) constitute one ALD cycle and they can repeat to build up films for a desired thickness. With suitable precursors, ALD theoretically can grow any inorganics and has to date produced a large variety of materials<sup>24,25</sup> including elements, oxides, sulfides, nitrides, and fluorides.

Analogous to ALD mechanistically, MLD can accurately grow pure and hybrid polymers with an accuracy at the molecular level. The molecular-level accuracy is determined by the long chains of MLD organic precursors. In case of growing pure polymers (Fig. 2a), the molecules of the precursor A first react with the reactive sites of a substrate via a corresponding linking chemistry to add a molecular layer with new reactive sites on the substrate surface.<sup>26</sup> Following a thorough purge A, the molecules of the precursor B react with the new reactive sites, thereby producing another molecular layer and recovering the surface back to the initial reactive groups. Another full purge B is performed to finish one MLD cycle. Through repeating the afore-discussed four steps, one can achieve the desired film thickness via MLD. Using adipoyl chloride (AC) and 1,6hexanediamine (HD) as precursors, 27,28 for example, an MLD process has been developed for growing nylon films linearly and the surface chemistry is described as follows:

$$\begin{aligned} |-\text{NH}_2 + \text{ClCO}(\text{CH}_2)_4 \text{COCl}(g) \\ \rightarrow |-\text{NHCO}(\text{CH}_2)_4 \text{COCl} + \text{HCl}(g) \end{aligned} \tag{2A}$$

$$\begin{aligned} |-\text{NHCO}(\text{CH}_2)_4\text{COCl} + \text{H}_2\text{N}(\text{CH}_2)_6\text{NH}_2(g) \\ \rightarrow |-\text{NHCO}(\text{CH}_2)_4\text{CO} - \text{NH}(\text{CH}_2)_6\text{NH}_2 + \text{HCl}(g). \end{aligned} (2B)$$

The AC-HD MLD process could realize a growth per cycle (GPC) of 19 Å per cycle at 62 °C. 28 It is apparent that the molecular layers of -CO(CH<sub>2</sub>)<sub>4</sub>CO- and -NH(CH<sub>2</sub>)<sub>6</sub>NH- during the MLD-nylon are much larger than the atomic layers of -Al- and -O- in the ALD-Al<sub>2</sub>O<sub>3</sub>. This underlies the higher GPC of the

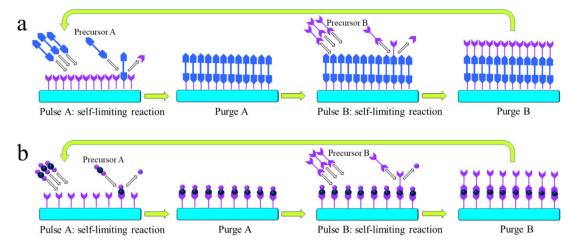


Fig. 2 Schematic illustrations of the MLD processes for growing (a) pure polymers and (b) organic-inorganic hybrid films.

MLD nylon process of AC-HD. Additionally, many more pure polymeric materials via MLD have been recently reported,<sup>20</sup> polyureas, 33-37 polyazomethines, 29-32 polyamides, <sup>27,28,38,39</sup> poly(3,4-ethylenedioxythiophene), <sup>40,41</sup> polyimide-polyamides, <sup>42</sup> polythioureas, <sup>43</sup> polyethylene terephthalate,44 and the others.45,46

In addition to pure polymeric films, MLD also enables organic-inorganic hybrids by adopting an ALD precursor and an MLD precursor (Fig. 2b), such as metal alkoxide materials (i.e., metalcones), in which diols can be used to couple with a metal precursor. For instance, a metal-based hybrid polymer can be synthesized using TMA and ethylene glycol (EG, HOCH<sub>2</sub>CH<sub>2</sub>OH, and a homobifunctional diol precursor). The resulting hybrid (i.e., AlEG, Al(OCH2CH2O)2) is an aluminum alkoxide (i.e., alucone) and its MLD surface chemistry can be described using the following reactions:<sup>47</sup>

$$|-OH + Al(CH_3)_3(g) \rightarrow |-O-Al(CH_3)_2 + CH_4(g)$$
 (3A)

$$\begin{split} |-O-Al(CH_3)_2 + 2HOCH_2CH_2OH(g) \\ \rightarrow |-OAl(OCH_2CH_2OH)_2 + 2CH_4(g) \end{split} \tag{3B}$$

Apparently, the molecular fragment of -OCH2CH2Oattached in the MLD alucone is far much larger than the atomic part of -O- in ALD Al<sub>2</sub>O<sub>3</sub>. This well explains that the resulting alucone has grown much faster than ALD Al<sub>2</sub>O<sub>3</sub>, accounting for 4 Å per cycle at 85 °C for the MLD alkoxide<sup>47</sup> versus 1.3 Å per cycle for ALD Al<sub>2</sub>O<sub>3</sub> at 80 °C. <sup>21</sup> Through smartly selecting precursors for their functional groups and backbones, MLD enables developing different metalcones or hybrid materials with desired properties. Substituting EG with the aromatic hydroquinone (HQ, HOC<sub>6</sub>H<sub>4</sub>OH), for example, another alucone has been deposited, which has its surface chemistry as follows:48

$$|-OH + Al(CH_3)_3(g) \rightarrow |-O-Al(CH_3)_2 + CH_4(g)$$
 (4A)

$$\begin{aligned} &\left| -\text{O-Al(CH}_3 \right)_2 + 2\text{HOC}_6\text{H}_4\text{OH (g)} \\ &\rightarrow \left| -\text{OAl(OC}_6\text{H}_4\text{OH)}_2 + 2\text{CH}_4 \text{ (g)}. \end{aligned} \tag{4B}$$

This TMA-HQ MLD process exhibits a GPC of 4.1 Å per cycle at 150 °C. 48 Alucones with different backbones are expected to exhibit different properties. The aromatic backbone of HQ is expected to provide structural stability and contribute largely to the electrical properties of the resulting polymer films. To date, many more metalcones including alucones, <sup>47–76</sup> zincones, <sup>57,77–84</sup> titanicones, <sup>57,77–86</sup> vanadicones, 87 zircones, 88,89 hafnicones, 90 mangancones, 62 metal quinolones, 91,92 and some other hybrid materials 93-108 have been reported.

The growth rate of both ALD and MLD is described by GPC. GPC is related to three parameters: precursor, processing temperature, and substrate. 22,23 Relying on the surface chemisorption to proceed with surface reactions while requiring no decomposition of precursors, consequently,23 the temperatures of ALD and MLD processes are generally low, typically no more than 300 °C. Adopting precursor pairs with high reactivity, the resulting ALD and MLD processes can be achieved at temperatures less than 100 °C and even room temperature (25 °C). The low processing temperature of ALD and MLD processes makes it possible to utilize some biological and polymeric templates unstable at high temperatures for some emerging applications. 112 Ascribed to their unique layerby-layer growth mechanism with accurate controllability, ALD and MLD can realize extremely uniform deposition over largescale two-dimensional (2D) planar substrates with a minimum roughness. For example, atomic force microscopy (AFM) has revealed a surface roughness of 1-3 Å for ALD Al<sub>2</sub>O<sub>3</sub> deposition in the range of 200–560 Å. 113–115 A typical MLD film roughness is in the range of 2-6 Å.20 The ALD/MLD-induced uniform films can also be realized on substrates with a large variety of morphologies, leading to conformal coatings. Thus, ALD and MLD feature their unparalleled capacities mainly in the following aspects: low processing temperature, precise growth accu-

racy, extremely uniform and conformal coverage, and a long list of inorganic, organic, and hybrid materials as thin films.

Thanks to the unmatched merits as thin film techniques, ALD and MLD have been gaining an ever-increasing attention for modifying interfaces of various advanced batteries in the past decade. The first report of the ALD practices in batteries was about an ALD TiN process in 2007, which was used to coat an Li<sub>4</sub>Ti<sub>5</sub>O<sub>12</sub> (LTO) anode powder to improve the resulting LTO anode's conductivity. 116 Later in 2010, two significant studies by Jung et al. for the first time reported that sub-nano ALD coatings (<1 nm) could be applied not only on electrode powders but also on prefabricated electrodes. 117,118 Since then, a new area has been formally unveiled for ALD and MLD as two novel tools to practice interface engineering of rechargeable batteries. Thus far, the choices of surface coatings via ALD have been greatly enriched, ranging from nitrides<sup>116</sup> and oxides 117-121 to fluorides, 122,123 sulfides, 124 phosphates, 125 and oxynitrides. 126 Besides LIBs, ALD has been attracting increasing attention for developing new batteries including Li-S, <sup>127,128</sup> Li-O<sub>2</sub>, <sup>129</sup> Na-based, <sup>130</sup> K-based, <sup>131</sup> Zn-based, <sup>132</sup> and Albased batteries. 133 In the case of MLD, Leobl et al. 58 was credited to the first attempt of MLD with an alucone coating for modifying LIBs in 2013. Subsequently, numerous studies of MLD polymeric coatings have been reported for modifying Si anodes, 71 Li metal anodes, 134 Na metal anodes, 135 and cathodes of Na-ion batteries. 136

Striving for addressing the two challenging issues (i.e., continuous formation of SEI and dendritic growth), many strategies and techniques have been applied. Among them, ALD and MLD have been recently demonstrated as two very promising techniques for novel coatings to tackle the issues of Li anodes. These efforts of ALD and MLD in interface engineering of LMBs are exhibited in three functionalization aspects: (1) surface coating of Li anodes, (2) tuning lithiophilicity of current collectors to facilitate Li deposition, and (3) constituting three-dimensional (3D) current collectors for hosting Li deposition, which will be introduced in detail in the following sections of this work.

## Surface coating of Li anodes

Surface coating is a facile and effective strategy to practice interface engineering of Li metal anodes. To protect the underlying Li metal, a desirable coating is expected to exhibit the following merits: (1) chemically stable in a highly reducing environment, (2) excellent ionic conductivity to facilitate Li stripping and plating, (3) exceptional electrical insulator to ensure no plating above the interface, (4) sufficient mechanical strength to sustain its integrity and inhibit lithium dendritic growth, (5) uniform film composition and properties, (6) high film quality free of defects, and (7) good adhesion on Li metal. ALD and MLD are distinguished by their unparalleled capabilities, *i.e.*, low process temperatures ( $\leq 150$  °C), uniform and conformal coverage, accurate control of coating thickness at the atomic and molecular level, and strong viability for numerous

films ranging from inorganic to organic and hybrid materials. 15,17,20,23,24 To date, a variety of inorganic and organic coatings via ALD and MLD have been investigated. They still could not satisfy all these afore-mentioned desirable merits but showed promising protection effects on Li anodes.

Due to the high reactivity of Li metal to air and moisture, it is important to avoid exposures during handling and transferring Li metal samples before and after surface coating via ALD or MLD. To do so, the ALD or MLD system is integrated with a glove box, as reported in the literature. 137,138 Owing to the low melting point of Li metal (~180 °C), in addition, the ALD or MLD can be performed at a temperature lower than 180 °C. In this respect, a large variety of ALD or MLD processes were possible at a temperature <150 °C, as reported in the literature. 137-140

#### 3.1. Inorganic surface coatings via ALD

The first practice of ALD on Li anodes was started from Al<sub>2</sub>O<sub>3</sub>, <sup>139,140</sup> followed by ZrO<sub>2</sub>, <sup>141</sup> TiO<sub>2</sub>, <sup>142</sup> LiF, <sup>143</sup> Li<sub>3</sub>PO<sub>4</sub>, <sup>144</sup> and Li<sub>x</sub>Al<sub>v</sub>S (LAS). 124 These ALD coatings are mainly thin, less than 15 nm. These studies verified that surface coating via ALD is effective in improving the cyclability of Li||Li symmetric cells, Li||Cu asymmetric cells, and Li||cathode LMB full cells. They served as protective films, which protected Li metal from oxidation and inhibited Li plating from dendritic growth. Among them, except for LAS being air-sensitive, the others could protect the Li metal from oxidation in air for varying durations, depending on the coatings' thicknesses. 139,141,142,144 Thicker coatings could protect the Li metal longer, up to several tens of hours. In comparison, the bare Li metal turned into black in air in a very short time, 1-5 min, due to its reaction with oxygen and moisture in the air. Additionally, it has also been confirmed that a 190 nm-thick ZrO2 coating could improve the thermal tolerance and shape the integrity of the Li metal. 141 All these surface coatings obtained via ALD have been examined to verify if they could suppress the formation of Li dendrites in a certain number of Li-stripping/plating cycles. During Li-stripping/plating processes, these thin ALD coatings might gradually diffuse into Li and got loss completely. For example, Al<sub>2</sub>O<sub>3</sub> and TiO<sub>2</sub> have been suggested to transform into Li<sub>x</sub>Al<sub>2</sub>O<sub>3</sub> <sup>139</sup> and Li<sub>2</sub>Ti<sub>2</sub>O<sub>4</sub>. <sup>142</sup> Thus, there might be a gradual evolution process for these coating layers and this process might have limited their lifetime.

Besides the oxide coatings, three Li-containing coatings, namely, LiF, 143 Li<sub>3</sub>PO<sub>4</sub>, 144 and LAS 124 were studied to date. LiF is the main component of an SEI layer in LIBs. It is electrochemically stable from 0 to 6.4 V,145 electronically insulating, and has a relatively high shear modulus of 55 GPa. 146 The shear modulus of a coating layer is critical in suppressing Li dendrites. The Li metal has a shear modulus of 4.25 GPa. 147 It was suggested by Monroe and Newman that the shear modulus should be at least twice (>8.5 GPa) that of the Li metal in order to prevent dendrite nucleation. 148 Chen et al. demonstrated with nanoindentation that the crystalline LiF film obtained via ALD has a sheer modulus of 58 GPa, 6-7 times higher than the value required to suppress Li dendrites. 143 They also revealed

that the ALD LiF coating has an ionic conductivity of 10<sup>-14</sup> S cm<sup>-1</sup> at room temperature. Furthermore, they demonstrated that an 8 nm-thick LiF coating could remarkably improve the cyclability of Li||Li symmetric cells and Li||Cu asymmetric cells, compared to bare cells. In another study, 149 an ALD LiF process had been applied to stitch two-dimensional (2D) h-BN nanocrystals through depositing at their point defects and line defects. The Cu foil coated by the resulting LiF-stitched h-BN film was able to suppress lithium dendrite formation. It enabled more than 300 Li-stripping/plating cycles in Li||Cu cells, which is much better than that of the bare Cu foil, LiFcoated Cu foil, and h-BN-coated Cu foil. Additionally, Li<sub>3</sub>PO<sub>4</sub> was investigated as a surface coating of Li metal. 144 It was reported that a 10 nm-thick Li<sub>3</sub>PO<sub>4</sub> coating is effective for extending the cyclability of Li||Li cells. Furthermore, the Li<sub>3</sub>PO<sub>4</sub>-coated Li was coupled with an NCA cathode and the resulting Li||NCA cell exhibited a higher sustainable capacity (125 vs. 105 mA h  $g^{-1}$  of bare cell) and a higher coulombic efficiency (99.8% vs. 92% of bare cell) in 150 charge/discharge cycles and facilitated achieving a higher rate capability. We reported a new ALD process<sup>124</sup> enabling a ternary sulfide compound of LAS through combining two sub-ALD processes of Li<sub>2</sub>S<sup>128</sup> and Al<sub>2</sub>S<sub>3</sub>. <sup>150</sup> In the study, we confirmed that the resulting film in a 1/1 sub-ALD cycle ratio of Li<sub>2</sub>S/Al<sub>2</sub>S<sub>3</sub> (i.e., 1:1 LAS) could achieve an ionic conductivity of  $2.5 \times 10^{-7}$  S cm<sup>-1</sup>

at room temperature. A 50 nm-thick 1:1 LAS film was coated onto Li and Cu foils, and the coated Li and Cu foils were then assembled into Li||Li and Li||Cu cells, respectively, for electrochemical evaluations. Using electrochemical impedance spectroscopy (EIS), our measurements revealed that the 1:1 LAS coating could stabilize the Li||Li symmetric cells' interface, remarkably reduce the formation SEI, and minimize the EIS. Compared to the bare LilLi cells, the 1:1 LAS-coated LilLi cells exhibited an impedance 5 times lower after stabilization (Fig. 3a). In addition, we found that the 50 nm-thick 1:1 LAS coating on Cu foils could help Lil|Cu cells achieve a much better cyclability and much higher sustainable coulombic efficiency (CE) (Fig. 3b). We further revealed that, compared to the evident Li dendrites formed on bare Cu foils (Fig. 3c and e), the 50 nm-thick 1:1 LAS coating on the Cu foil prevented the formation of Li dendrites during plating (Fig. 3d and f). By tuning the sub-ALD cycle ratio of Li<sub>2</sub>S/Al<sub>2</sub>S<sub>3</sub> to 1/4, in a subsequent study we found that the 1:4 LAS can achieve a much higher ionic conductivity of 10<sup>-3</sup> S cm<sup>-1</sup> at room temperature. 151

#### 3.2. Organic surface coatings via MLD

Following some early efforts by ALD, MLD has also been applied to develop polymeric coatings for addressing the issues of Li metal anodes. In 2018, two independent studies commonly investigated the same alucone AlEG as a new

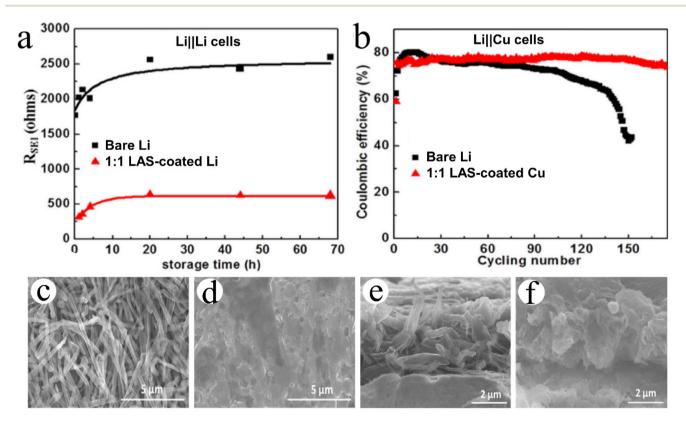


Fig. 3 Effects of ALD Li<sub>x</sub>Al<sub>y</sub>S on Li metal anodes and Cu current collectors: 124 (a) R<sub>SEI</sub> of Li/electrolyte/Li symmetric cells versus storage time. (b) Coulombic efficiency of Li platting/stripping in 1 M LiPF<sub>6</sub> in 3:7 EC/EMC (EC = ethylene carbonate and EMC = ethyl methyl carbonate). (c and d) Top-view and (e and f) cross-sectional SEM images of Li metal deposited on (c and e) pristine Cu and (d and f) Cu coated with a 50 nm LixAlvS ALD film. Reprinted (adapted) with permission from ref. 124. Copyright (2016) John Wiley and Sons.

coating over Li metal anodes. 134,152 They applied two different MLD process temperatures: 150 and 120 °C. Chen et al. 152 disclosed that, compared to bare Li||Li cells, the symmetric Li||Li cells coated by a 6 nm AlEG coating enabled a much more stable voltage profile. Bare Li||Li cells failed after ~158 h, while the AlEG-coated LillLi cells survived over 200 h with a gradually increased overpotential. The beneficial effects of AlEG coatings were also revealed in another study by Zhao et al. 134 Their optimal coating thickness is ~25 nm. In particular, they comparatively demonstrated that the AlEG coating by MLD is better than that of the Al<sub>2</sub>O<sub>3</sub> coating by ALD in improving cell cyclability in Li||Li cells, probably due to the better flexibility of the MLD AlEG coating. Similarly, ZrEG was also studied as a coating of Li metal anodes and it was disclosed that a 4 nm-thick coating could remarkably help improve Li|| Li cells' performance. 153

In addition to the afore-discussed studies on metalcones, there was also a study investigating a pure polymer, polyurea (PU), via MLD. 154 In the study, Sun et al. deposited PU on Li metal anodes at a GPC of ~0.4 nm per cycle at 65 °C. They reported that a 4 nm-thick PU (10 cycles of the PU MLD process, i.e., Li@P10) could well protect Li metal from corrosion, remarkably extend the cyclability, and stabilize the overpotential of Li||Li cells (Fig. 4a). The PU-modified Li||Li cells could achieve a long cyclability more than 1000 h. Furthermore, they coupled the Li@P10 anode with an LFP cathode and investigated the resulting Li||LFP LMB cells' performance. They revealed that the Li@P10 could help achieve better sustainable capacity (Fig. 4b) and better rate capacity (Fig. 4c-e).

Different from all these afore-discussed studies on Li-free polymeric coatings, we have recently been focusing on develop-

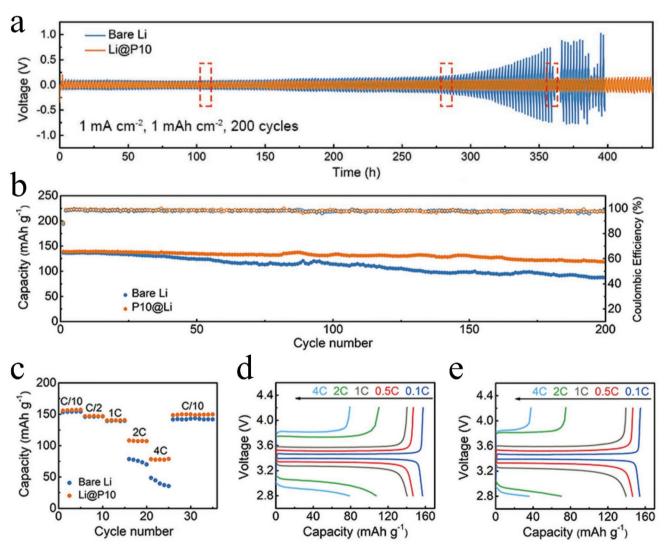


Fig. 4 Effects of MLD polyurea on Li metal anodes: 154 the performance of (a) Li||Li symmetric cells at 1 mA cm<sup>-2</sup> and 1 mA h cm<sup>-2</sup> and Li||LFP LMB full cells at (b) a rate of 1C (i.e., 170 mA  $q^{-1}$ ) and (c) different rates ranging from 0.1 to 4C. Galvanostatic charge/discharge voltage profiles of (d) Li@P10 and (e) bare Li. The electrolyte is 1 M LiPF6 in 1/1/1 volume ratio of EC/DEC/DMC (EC = ethylene carbonate, DEC = diethyl carbonate, and DMC = dimethyl carbonate). Reprinted (adapted) with permission from ref. 154. Copyright (2019) John Wiley and Sons.

ing lithicones, Li-containing polymers, including LiGL (GL = glycerol)<sup>137</sup> and LiTEA (TEA = triethanolamine)<sup>138</sup> reported to date using MLD. Compared to the above-mentioned metalcones and pure polymers, our lithicones endowed much better performance to Li||Li and Li||NMC cells. Particularly, our LiGL MLD exhibited the highest GPC of ~2.7 nm per cycle at 150 °C and could coat graphene nanosheets (GNS) conformally (Fig. 5a-c). This LiGL coating was applied on Li metal anodes with different coating thicknesses by controlling its MLD cycles. The resulting Li metal anodes were named LiGLXX, where XX indicates MLD cycles. For example, LiGL10 signifies the Li metal anodes coated by 10 MLD cycles of LiGL, and so

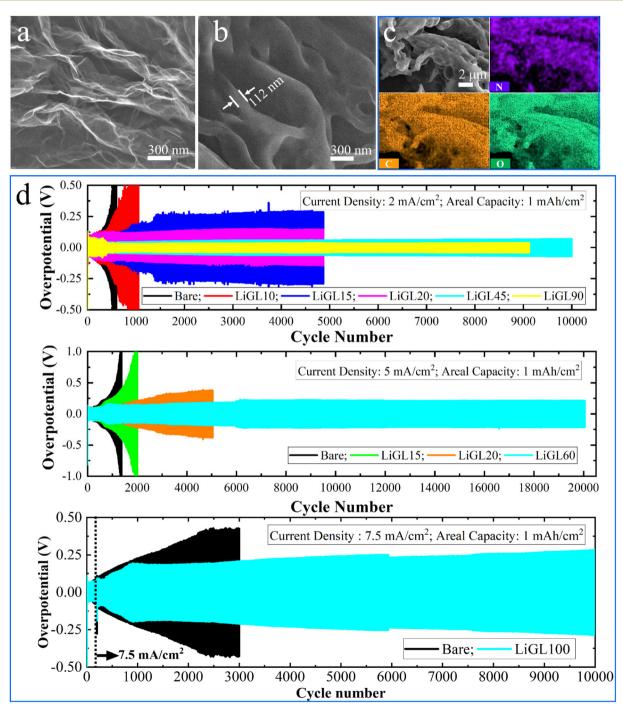


Fig. 5 Effects of MLD LiGL on Li metal anodes: 137 (a) bare GNS, (b) GNS coated by 20-MLD-cycle of LiGL, (c) EDX mapping of LiGL-coated GNS, and (d) effects of LiGL on Li anodes at different current densities (2, 5, and 7.5 mA cm<sup>-2</sup>) and a fixed areal capacity of 1 mA h cm<sup>-2</sup>. The electrolyte is 1 M LiTFSI (lithium bis(trifluoromethanesulfonyl)imide) in 1/1 volume ratio of DOL/DME (DOL = 1,3-dioxalane and DME = 1,2-dimethoxyethane). Reprinted (adapted) with permission from ref. 137 under a Creative Commons Attribution (CC BY) license.

forth. Very excitingly, it was for the first time reported that Li metal anodes can be coated with a very thick LiGL film over 200 nm or higher but still achieve a superlong cyclability of over 20000 Li-stripping/plating cycles (over 10000 h) without failures (Fig. 5d). In addition, this LiGL coating can tolerate a high areal current density of up to 7.5 mA cm<sup>-2</sup> or higher. Impressively, our observation using a scanning electron microscope (SEM) uncovered that the Li metal can be well protected from corrosion (SEI and dendrites) with a sufficiently thick LiGL coating (e.g., LiGL60) (Fig. 6a and b). Our analyses by X-ray photoelectron spectroscopy (XPS) further confirmed that, compared to the thick SEI layer (indicated by the thickness of fluorine (F) from the decomposition of LiTFSI, where LiTFSI used the Li salt in the electrolyte) formed on the bare Li metal after 10 Li-stripping/plating cycles (Fig. 6c), the LiGL90 is SEIfree after 10 (Fig. 6d) and 50 Li-stripping/plating cycles (Fig. 6e). We further studied the exceptional protection effects of the LiGL coating in a novel experiment by performing ultralong stripping/plating processes for up to 24 h at 2 mA cm<sup>-2</sup> in Li||Li cells. After a 24 h stripping (Fig. 7a), we noticed many erupted spots on bare Li. These erupted spots were not uniformly distributed. Very strikingly, on the other side, 24 h plating formed a top layer comprising a large number of dendritic structures (Fig. 7b). In sharp contrast, LiGL60 was smooth but decorated with many cracks after 24 h stripping (Fig. 7c) and plating (Fig. 7d). In the study, we confirmed that these cracks are due to the mechanical press during cell assembling but not due to the stripping and plating. These compelling results well verified that the LiGL coating can effectively protect the Li metal from corrosion. Following this stripping/plating process, we subsequently conducted a reverted 24 h plating/stripping process. Again, we confirmed that bare Li anodes suffered from SEI and dendritic growth (Fig. 8a and b), while LiGL60 was nearly intact and did not show any corrosion (Fig. 8c and d). We ascribed the excellent protection of the LiGL coating over Li anodes to its excellent properties, i.e., exceptional ionic conductivity, excellent electrical insulator, good flexibility, and outstanding chemical compatibility and stability. However, we also noticed the cracks of LiGL, indicating that the mechanical properties of LiGL should be further

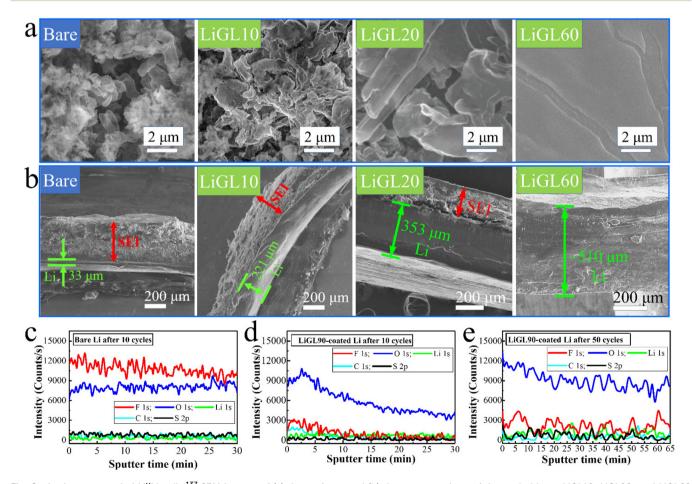


Fig. 6 Analyses on cycled Li||Li cells: 137 SEM images of (a) the surfaces and (b) the cross-sections of the cycled bare, LiGL10, LiGL20, and LiGL60 electrodes after 700 Li-stripping/plating cycles. XPS depth profiling on (c) bare and (d and e) LiGL90 electrodes after (c and d) 10 and (e) 50 Li-stripping/plating cycles. The electrolyte is 1 M LiTFSI in 1/1 volume ratio of DOL/DME. LiGL10, LiGL20, LiGL60, and LiGL90 indicate the LiGL coatings of 10, 20, 60, and 90 MLD cycles, respectively. Reprinted (adapted) with permission from ref. 137 under a Creative Commons Attribution (CC BY)

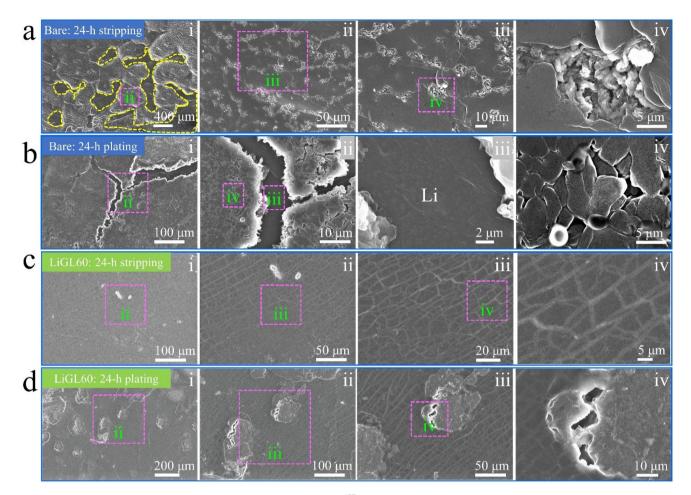


Fig. 7 SEM observations of the morphological changes of Li electrodes: 137 (a and b) bare Li electrode and (c and d) LiGL60 electrode after one 24 h stripping (or plating) at 2 mA cm<sup>-2</sup>. LiGL60 indicates the LiGL coating of 60 MLD cycles. The electrolyte is 1 M LiTFSI in 1/1 volume ratio of DOL/ DME. Reprinted (adapted) with permission from ref. 137 under a Creative Commons Attribution (CC BY) license.

addressed. The excellent protection effects of LiGL have also been further studied for improving Li||NMC LMB cells. The results will be reported somewhere else.

In another recent work, 138 we have reported LiTEA, a new lithicone obtained via MLD, which also enables the protection of Li anodes evidently. In Li||Li cells, the LiTEA coating could help achieve a cyclability of over 10000 Li-stripping/plating cycles (>4000 h) without failures at 5 mA cm<sup>-2</sup> and 1 mA h cm<sup>-2</sup>. We also confirmed that, protected by a sufficiently thick LiTEA coating (> ~30 nm), an Li anode could avoid forming SEI and growing dendrites. We also demonstrated that Li anodes coated with 200 MLD cycles (~70 nm) of LiTEA (i.e., LiTEA200) can remarkably improve the cyclability of Li|| NMC811 (Fig. 9). To couple with NMC811 coated by 20 cycles (~2nm) of ALD Li<sub>2</sub>S (*i.e.*, Li<sub>2</sub>S20), <sup>155</sup> the resulting LiTEA200|| Li<sub>2</sub>S20 LMB cells enabled a much better cyclability (Fig. 9a). In addition, we used an energy-dispersive X-ray (EDX) spectrometer to detect the Ni content on the Li anodes after 300 charge/discharge cycles. We found that there are comparable Ni contents on the Li anodes of bare Li||NMC811 and LiTEA200||NMC811 (Fig. 9b and c), but a much lower Ni

content on the Li anode of LiTEA200||Li<sub>2</sub>S20 (Fig. 9d). This indicates that, to achieve the best cell performance, it would be desirable to tackle the issues of both Li anodes and cathodes together.

#### 3.3. Hybrid surface coatings by ALD and MLD

Not limited to a single coating layer via ALD or MLD, very interestingly, Zhao et al. 156 have recently developed bilayered hybrid protective films consisting of an MLD-deposited organic layer, alucone (AlEG) and an ALD deposited inorganic layer, Al<sub>2</sub>O<sub>3</sub>. This combination features tunable layer thickness and property to achieve the optimal protection effects. In Li Li symmetric cells, they found that 50MLD/50ALD/Li (where "50" is the ALD/MLD cycle number and they were deposited in a bilayered film on Li anodes) performed the best, compared to the 50ALD/50MLD/Li and the bare samples under different testing conditions. Furthermore, the 50MLD/50ALD/Li anodes were used to couple with an S cathode and an LFP cathode in LMB full cells. Compared to the pristine Li foil, the 50MLD/ 50ALD/Li enabled much better performance for the full cells

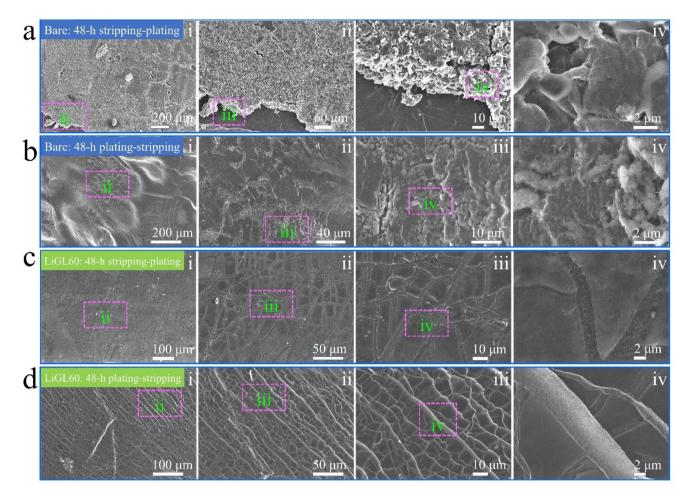


Fig. 8 SEM observations of the morphological changes of Li electrodes: 137 (a and b) bare Li electrode and (c and d) LiGL60 electrode after one 48 h stripping-plating at 2 mA cm<sup>-2</sup>. LiGL60 indicates the LiGL coating of 60 MLD cycles. The electrolyte is 1 M LiTFSI in 1/1 volume ratio of DOL/DME. Reprinted (adapted) with permission from ref. 137 under a Creative Commons Attribution (CC BY) license.

of Li||S and Li||LFP, in terms of sustainable capacity and cyclability.

### Tuning lithiophilicity of current collectors

In addition to the afore-discussed protective coatings obtained via ALD/MLD, ALD has been applied to modify the current collector-anode interface by growing a thin nucleation layer. The ALD-deposited nucleation layer could tune the Li metal plating morphology for mitigating SEI and dendrite growth.

A copper foil is widely used as the current collector of anodes, including Li metal. Unfortunately, the copper foil exhibits a lithiophobic nature, which presents a high energy barrier for the nucleation of lithium. Such a high nucleation barrier (i.e., overpotential) results in the formation of small and densely distributed lithium particles, increases the contact area with the electrolyte, and thereby leads to the evident formation of SEI, Li dendrites, and cell failure. In addressing these issues, various zero overpotential metallic

seeds (Ag and Au) have been studied. Their high costs have prompted researchers to search for cost-effective alternatives. In this regard, we conducted the first study to investigated the effects of 1:1 LAS on the performance of Li||Cu cells, in which the 1:1 LAS coating was applied on the Cu foil via ALD. 124 It was found that 25-50 nm-thick LAS-coated Cu helped Li||Cu cells achieve much longer cyclability (Fig. 3b). In addition, we observed that there were numerous dendritic structures on the pristine Cu foil (Fig. 3c and e), while no dendrites were observed on a 50 nm-thick 1:1 LAS-coated Cu after an Li plating process (Fig. 3d and f). In a recent study, Tan et al. have studied the effects of TiO2 nanocoating on the performance of Li||Cu cells. 157 They deposited the TiO2 coating on the Cu foil with different ALD cycles, while the ALD process has a GPC of 0.8 nm. They revealed that all the ALD TiO2 coatings of different thicknesses (10, 20, and 30 nm) could help improve the performance of Li||Cu cells, compared to the bare Li||Cu cell. Particularly, the Cu coated with 20 nm-thick TiO<sub>2</sub> (i.e., Cu-20TiO<sub>2</sub>) realized the highest CE, the longest cyclability, and the lowest interfacial resistance of the Li||Cu cell. They also noticed that Cu-20TiO<sub>2</sub> lowered the nucleation overpoten-

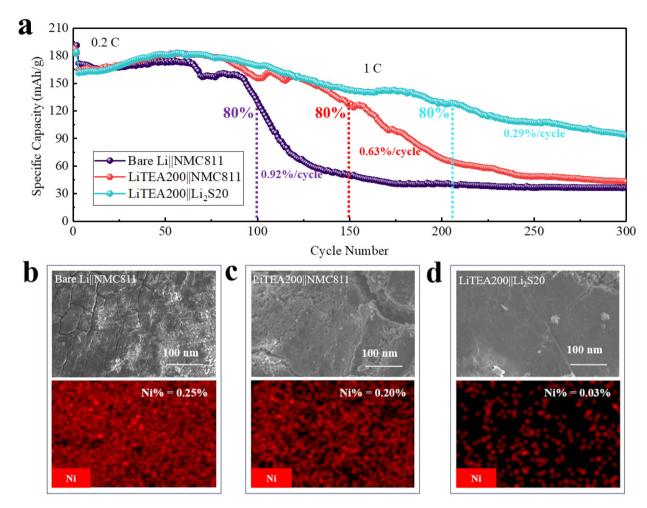


Fig. 9 Effects of ALD Li<sub>2</sub>S and MLD LiTEA on the performance of Li||NMC811 LMB cells: 138 (a) cycling performance of Li||NMC full cells. SEM images and EDX mapping of cycled Li electrodes disassembled from (b) bare Li||NMC811, (c) LiTEA200||NMC811, and (d) LiTEA200||Li<sub>2</sub>S20 cells. NMC811 is the cathode of  $LiNi_{0.8}Mn_{0.1}Co_{0.1}O_2$ . LiTEA200 indicates the Li anode with an LiTEA coating of 200 MLD cycles, while  $Li_2S20$  signifies the NMC911 cathode with an Li<sub>2</sub>S coating of 20 ALD cycles. All cells were cycled at 1C (1C = 200 mA  $g^{-1}$ ) for 300 cycles. The electrolyte is 1.2 M LiPF<sub>6</sub> in 3/7 weight ratio of EC/EMC. Reprinted (adapted) with permission from ref. 138. Copyright (2023) Elsevier.

tial and voltage hysteresis of the Li||Cu cell (Fig. 10a). Tan et al. ascribed these improvements to the better lithiophilicity of Cu-20TiO<sub>2</sub> (due to the 20 nm-thick TiO<sub>2</sub> coating) than that of bare Cu, which could have helped form a more stable and thinner SEI and reduced the energy barrier of Li nucleation. In their study, Tan et al. further demonstrated that, through predepositing 5 mA h cm<sup>-2</sup> of Li on the bare Cu and the Cu-20TiO2, the latter enabled a much better cyclability and a much lower interfacial resistance of Li||LFP full cells (Fig. 10b). The SEM observations revealed that, compared to the pre-deposited Li on the bare Cu (Fig. 10c), the pre-deposited Li on the Cu-20TiO2 (Fig. 10d) is much denser. After 50 charge/discharge cycles of Li||LFP cells, Li on bare Cu (Fig. 10e) became more porous than Li on Cu-20TiO<sub>2</sub> (Fig. 10f).

In spite of the findings on the beneficial effects of the ALD LAS and TiO2 coating layers on the improved performance of Li||Cu cells, the afore-discussed studies 124,157 did not provide an in-depth understanding on the underlying mechanism of these coating layers. In this regard, Oyakhire et al. 158 conducted an inspiring study and clearly demonstrated that the ALD TiO2 coating layer could lower the energy barrier of lithium nucleation and thereby help lithium nucleate into larger deposits. Therefore, the deposited Li has a reduced surface area in contact with the electrolyte and forms less SEI, leading to an improved cell performance. Particularly, Oyakhire et al. 158 emphasized the importance of ALD for tuning lithophilicity in the following aspects: (1) conformality of the coating layer, (2) scalability at ease, (3) excellent controllability over the coating thickness, and (4) without compromise on cell energy density. In their study, Oyakhire et al. 158 also noticed that a nanoscale TiO2 coating obtained by ALD could dramatically improve the cyclability of Li||Cu cells, while a coating thickness of 5 nm was optimal. Based on lithiation potential curves (inset of Fig. 11a), they found that the nucleation overpotential of lithiation was continuously reduced from

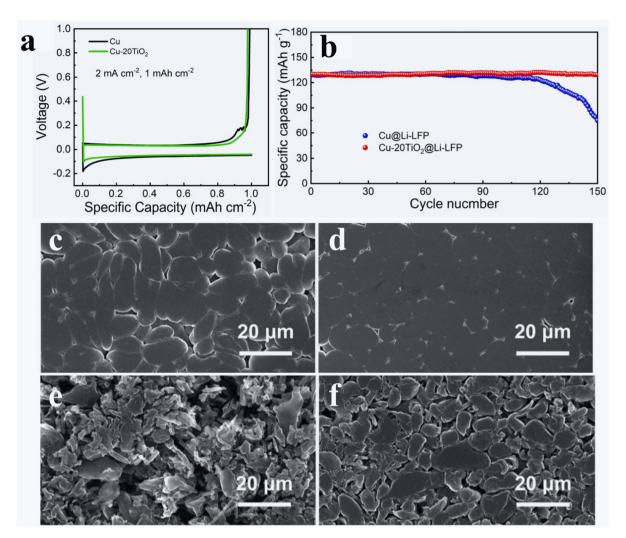


Fig. 10 Effects of ALD TiO<sub>2</sub> on the surface lithiophilicity of the Cu foil: 157 (a) 1st galvanostatic plating/stripping profiles of Cu and Cu-20TiO<sub>2</sub> collectors under 1 mA cm<sup>-1</sup> and 1 mA h cm<sup>-2</sup>. (b) Cycling performance of Li||LFP LMB full cells at 1C. SEM images of (c and e) Cu@Li and (d and f) Cu-20TiO<sub>2</sub>@Li (c and d) before and (e and f) after 50 charge/discharge cycles in Li||LFP cells. The electrolyte is 1 M LiTFSI in 1/1 volume ratio of DOL/ DME with 2 wt% LiNO<sub>3</sub>. Reprinted (adapted) with permission from ref. 157. Copyright (2020) Elsevier.

129.5 mV on bare Cu to 20.2 mV on the 5 nm-TiO2 coated Cu with the increase in coating thickness (Fig. 11a). However, a further increase in the TiO2 coating thickness to 10 nm increased the nucleation overpotential, compared to that of 5 nm TiO<sub>2</sub>-coated Cu, probably due to the increased electronic resistance of the coating layer. Very interestingly, Oyakhire et al.158 visualized the morphology of lithium after the first plating under different capacities of 0.1, 0.3, and 1 mA h cm<sup>-2</sup> but at a fixed current density of 1 mA cm<sup>-2</sup>. It was revealed that, after a certain capacity (e.g., 0.3 mA h cm<sup>-2</sup>), there were more isolated small nuclei of lithium on the bare Cu (Fig. 11b), but less large nuclei of lithium on 5 nm TiO<sub>2</sub>coated Cu (Fig. 11c). They believed that the reason lied in the TiO<sub>2</sub> coating layer enabling coalescence of nucleated adatoms and being favorable to the lateral growth of lithium particles. On the contrary, lithium adatoms have poor affinity to bare Cu. After the same capacity of lithium

deposition, consequently, the deposited lithium on bare Cu has more exposed surface area and thereby forms more SEI. In comparison, the deposited lithium on the 5 nm TiO<sub>2</sub>coated Cu has less exposed surface area and produces less SEI. Using XPS, Oyakhire  $et\ al.^{158}$  verified that lithium was deposited on the top of the TiO2 coating layer. They further probed the lithiophilicity of TiO2 and noticed a sloping voltage profile with Li||Cu cells using TiO2-coated Cu (Inset of Fig. 11a). With the increase in the thickness of the TiO<sub>2</sub> layer, particularly, the sloping potential profile increased with an increased capacity. This suggested that some lithium ions have reacted with the TiO<sub>2</sub> layer before lithium nucleation, leading to the production of LixTiO2. They further postulated that the resulting LixTiO2 layer might have favorable wetting properties to lithium and led to larger lithium particles and improved continuity of the plated lithium metal, as illustrated in Fig. 11d.

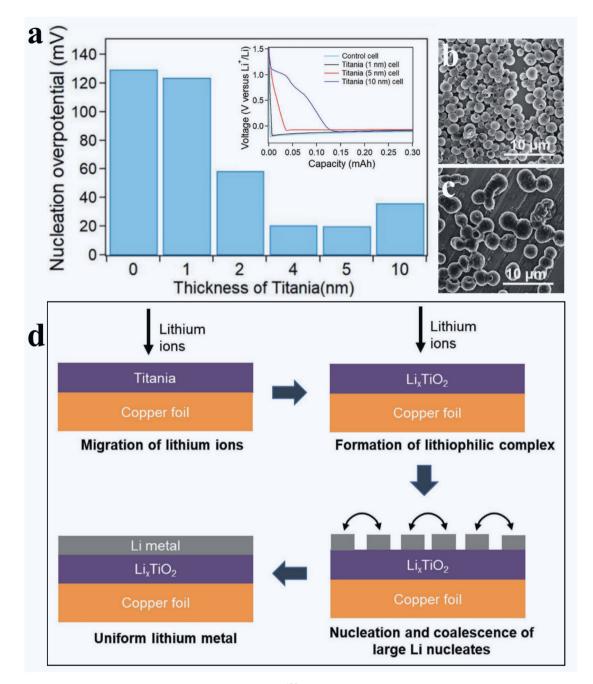


Fig. 11 Effects of ALD TiO<sub>2</sub> on the surface lithiophilicity of the Cu foil. (a) First cycle nucleation overpotential as a function of ALD TiO<sub>2</sub> thickness (inset: voltage profiles for the first cycle of lithium plating for control cell, 1, 5, and 10 nm TiO<sub>2</sub> cells). Top-view SEM images of 0.3 mA h cm<sup>-2</sup> lithium embryos formed in (b) the control cell and (c) 5 nm TiO2 cell. (d) Schematic illustration of the role of TiO2 as a nucleation layer for electrodeposited Li. The electrolyte is 1 M LiTFSI in 1/1 volume ratio of DOL/DME with 1 wt% LiNO3. Reprinted (adapted) with permission from ref. 158. Copyright (2020) John Wiley and Sons.

#### Constituting 3D current collectors 5.

In addition to the surface coatings on planar Li and Cu foils as discussed above, ALD has been applied to modify various 3D porous templates to improve their lithiophilicity. The resulting lithiophilic 3D templates were used as Li hosts in LMB cells for inhibiting SEI and Li dendrite formation. These 3D templates are in general chemically and

electrochemically inert and have several functions: 159 (1) provide a constant electrode volume; (2) confine Li within the templates; and (3) reduce local current density to alleviate dendrite growth. ALD coatings play very critical roles for these 3D Li hosts: (1) improve lithiophilicity and (2) enhance the mechanical strength of these Li hosts. The ALD coatings reported to date range from several nanometers to several tens of nanometers.

Liu et al. 159 first demonstrated an ALD-modified 3D porous Li host through coating a conformal layer of 30 nm-thick ZnO film over an electrospun polyimide (PI) fiber matrix. The resulting ZnO-coated PI matrix was then put into contact with and covered completely by molten Li. Liu et al. verified that molten Li cannot wet the bare PI matrix, while Li reacts with ZnO resulting in the production of an LiZn alloy and Li<sub>2</sub>O. The conformal ZnO coating provided the driving force for the molten Li infusion. The resulting Li-coated PI-ZnO matrix was demonstrated to be effective to remarkably improve the cyclability of Li||Li cells and mitigate the cell overpotential. Such a strategy of ALD ZnO was also later practiced on different 3D templates including Cu pillars, 160 carbon fibers, 161,162 and Cu foams (CFs). 163 Using ALD Al<sub>2</sub>O<sub>3</sub>, this strategy was also applied on a carbon nanotube sponge (CNTS)<sup>164</sup> and cotton.<sup>165</sup> Among these ALD-modified 3D Li hosts, a ZnO-coated hierarchical CF has exhibited compelling effects on the resulting Li||LFP and Li||LCO LMBs. 163 CFs typically have low surface areas. To increase the surface area of a CF (Fig. 12a), Zhang et al. 163 first grew Cu(OH)2 nanofibers

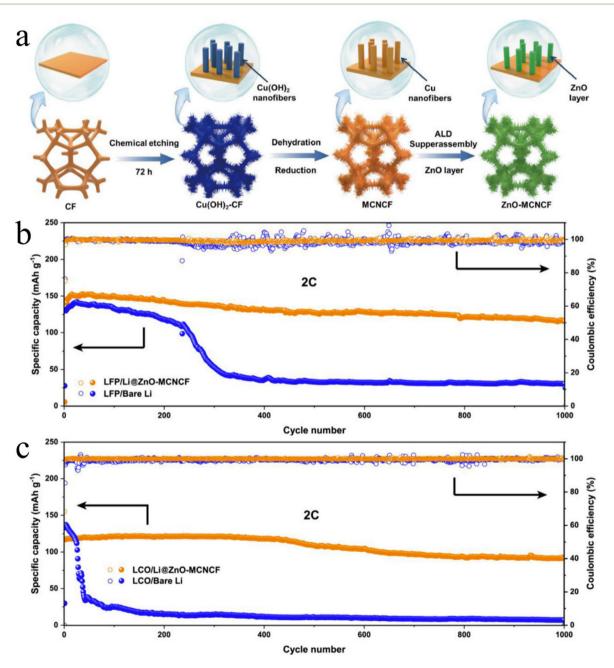


Fig. 12 Effects of ALD ZnO on 3D hierarchical Cu foams: 163 (a) schematic illustration of the preparation process of Zn-MCNCF from CF. Electrochemical performance of (b) Li||LFP and (c) Li||LCO cells due to the adoption of Li@ZnO-MCNCF. The electrolyte is 1 M LiFP<sub>6</sub> in 1/1/1 volume ratio of EC/DMC/DEC. Reprinted (adapted) with permission from ref. 163. Copyright (2021) Elsevier.

over a CF (Fig. 12a) via a wet chemistry process and then annealed them in a reducing environment to achieve multilevel Cu nanofibers on the CF (MCNCF) (Fig. 12a). The MCNCF was further coated conformally with ZnO via ALD (i.e., ZnO-MCNCF) (Fig. 12a). Then, the ZnO-MCNCF was deposited with Li for 10 mA h cm<sup>-2</sup> at 1 mA cm<sup>-2</sup> in Li||ZnO-MCNCF cells. Zhang et al. found that the Li deposited on the CF (Li@CF) was loose and uneven, while Li deposited on the MCNCF (Li@MCNCF) was uniform but only on the upper layer of the MCNCF. In comparison, the Li deposited on the ZnO-MCNCF (Li@ZnO-MCNCF) was uniform across the ZnO-MCNCF skeleton. The resulting Li@ZnO-MCNCF anodes were used for testing in Li||Li symmetric cells and Li||LFP and Li||LCO full cells. Compared to Li@CF and Li@MCNCF, the Li@ZnO-MCNCF could achieve the longest cyclability with the lowest overpotential in Li||Li cells. Very impressively, the Li@ZnO-MCNCF could achieve very long cyclability (1000 cycles) and very stable sustainable capacities in Li||LFP (Fig. 12b) and LillLCO (Fig. 12c) LMBs at a high rate of 2 C. This work clearly shows that it is very promising to tackle the issues of Li anodes through adopting suitable measures, while ALD is a very useful technique. Compared to the other 3D Li hosts (Cu pillars, 160 carbon fibers, 161,162 CNTS, 164 and cotton<sup>165</sup>) aided by ALD, this Li@ZnO-MCNCF 3D structure enabled much better electrochemical performance. The underlying mechanisms of the Li@ZnO-MCNCF 3D structure lie in two aspects: (1) excellent lithiophilicity due to the ALD ZnO coating and (2) high specific surface area ascribed to the MCNCF skeleton.

#### Conclusions and outlook

Li metal is the "holy grail" of rechargeable batteries, owing to its highest capacity and lowest potential. The commercialization of Li metal anodes will enable a series of new battery technologies, LMBs, which feature a much higher energy density than that of LIBs. LMBs are highly regarded for addressing the range anxiety of EVs, thereby boosting the EV market. To this end, it is urgent to address the two daunting issues, i.e., continuous SEI formation and dendrite growth. These two issues are two interfacial issues. Thus, interface engineering is very critical for LMBs.

Among various techniques for interface engineering, ALD and MLD are two emerging ones having several unmatched features. Ascribed to their unique growth mechanism and distinctive operation principle, ALD and MLD are granted with a series of unparalleled merits for growing thin films, including exceptional controllability over material growth with atomic and molecular accuracy, low process temperatures, excellent film uniformity and conformality, and unlimited opportunities for new materials. These advantages are essential for ALD and MLD as two novel techniques to practice interface engineering with new solutions in LMBs. First, their low process temperatures make them feasible to deposit films over the Li metal. Second, their viability for inorganic, organic, and hybrid coatings provides an inexhaustible source for searching the most suitable materials with favorable properties to best fulfill interface engineering. Third, their excellent material controllability paves a technical pathway to offer optimal film quality and thickness. Last but not least, their uniformity and conformality are two unrivaled assets for interface engineering of LMBs.

As a consequence, ALD and MLD have to date exhibited three technical pathways for tackling the issues of Li metal anodes: (1) surface coating of Li anodes, (2) tuning lithiophilicity of current collectors, and (3) designing novel 3D Li hosts. In the first place, the effects of surface coatings are highly related to the coatings' properties such as mechanical strength, ionic and electrical conductivity, and chemical and electrochemical stability. In this aspect, desirable coatings via ALD and MLD have not been well investigated and there is still a huge space to explore. Our recent studies 124,137,138 for Li-containing organic and inorganic coatings are very compelling and worth some future in-depth studies. Additionally, combining ALD and MLD for hybrid materials is another strategy for novel coatings with desirable properties. To achieve the best performance of Li metal anodes, it may be desirable to have the hybrid coatings made from two excellent organic and inorganic coatings. In the second place, the use of ALD/MLD coatings to tune surface lithiophilicity has not been widely investigated. The studies discussed in this work are still limited. Thus, we would expect more studies to be conducted to disclose the effects of different coatings on lithiophilicity and find zero overpotential coatings with high feasibility technically and financially. In this aspect, only limited ALD coatings have been studied but no MLD coatings have been reported yet. In the third place, limited ALD coatings (ZnO and Al<sub>2</sub>O<sub>3</sub>) have been applied to modify 3D architecture templates. In the future, it is expected that more ALD/MLD coatings will be investigated. In addition, 3D templates having commercialization potential are preferred.

While we are expecting many more new ALD/MLD coatings with favorable properties to be developed, future studies are also anticipated to evaluate them under much harsher testing conditions (e.g., higher areal current densities and areal capacities, lower and higher temperatures, and different electrolytes). Researchers need to consider the requirements for commercialization. In this respect, the current densities and capacities adopted for testing may not be sufficient for commercialization. Furthermore, it is particularly significant to address the effects of different electrolytes on ALD/MLD coatings. Typically, there are two types of liquid electrolytes used in previous studies, i.e., ether and carbonate, but to date there are less studies in this field. In our studies, we have noticed that the same ALD/MLD coatings may have different effects on the performance of Li metal anodes in different liquid electrolytes. It will be very instructive to uncover the underlying mechanisms. For a certain ALD/MLD coating, one needs to consider the following aspects in order to best practice the coating: (1) its chemical compatibility in different electrolytes and (2) its electrochemical stability with the electrolytes. Not limited to depositing surface coatings in liquid cells, ALD and

MLD are also two powerful tools for rationally designing and developing advanced SEs (iSEs, pSEs, or cSEs). In this respect, we have recently made a comprehensive review on SEs *via* ALD.<sup>15</sup> pSEs and cSEs *via* MLD or/and ALD are currently still at their very early stage. Some Li-containing polymers obtained recently *via* MLD may be promising pSEs.<sup>137,138</sup> They may be combined/mixed with iSEs *via* ALD to form advanced cSEs. Thus, there is still a lot of room for ALD and MLD to boost new battery technologies.

In short, ALD and MLD are two unique tools for practicing interface engineering for LMBs. The studies reported to date in the literature are very interesting, but many more efforts are urgently needed to further advance novel technologies and gain new knowledge for the commercialization of Li metal anodes.

#### Conflicts of interest

There are no conflicts to declare.

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